

Applicant Initiated Interview Request Form -- faxed to: 571. 270. 8655 (3 pp.)

In re the Application of

Akio ENOMOTO et al.

Group Art Unit: 1746

Application No.: 10/591,296

Examiner: J. RIVERA

Filed: August 31, 2006

Docket No.: 129280

For: FILM BONDING MACHINE

Tentative Participants:

- (1) Brian Kauffman (2) Examiner Rivcra
 (3) _____ (4) _____

Confirmed Date of Interview: April 13, 2011 Proposed Time: 11:00 AM (AM/PM)**Type of Interview Requested:**

- (1) ☐ Telephonic (2) ☒ Personal (3) ☐ Video Conference

Exhibit To Be Shown or Demonstrated: ☐ YES ☒ NO

If yes, provide brief description: _____

Issues To Be Discussed

Issues (Rej., Obj., etc)	Claims/ Fig. #s	Prior Art	Discussed	Agreed	Not Agreed
(1) §103(a) Rej.	1, 4-9 and 11	Fukuta, Onodera, Yamamura and Kanchara	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
(2) _____	_____	_____	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
(3) _____	_____	_____	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>

☐ Continuation Sheet Attached**Brief Description of Arguments to be Presented:**

The stripping section of Yamamura does not correspond to the winding element of claim 1. Also, the references would not have rendered obvious the features of claims 12 and 13 in the attached Appendix.

An interview was conducted on the above-identified application on _____

NOTE:

This form should be completed by applicant and submitted to the examiner in advance of the interview (see MPEP § 713.01).

This application will not be delayed from issue because of applicant's failure to submit a written record of this interview. Therefore, applicant is advised to file a statement of substance of this interview (37 CFR 1.133(b)) as soon as possible.

(Applicant/Applicant's Representative Signature)_____
(Examiner/SPE Signature)

APPENDIX

1. (Currently Amended) A film bonding machine comprising:

a honeycomb structural body mover capable of gripping and moving a honeycomb structural body to an intended location;

a tape bonder that bonds ~~a~~an uncut tape onto an end surface of the honeycomb structural body;

a laser oscillator that oscillates a laser so as to perform cutting processing of the tape bonded onto the end surface of the honeycomb structural body to obtain the honeycomb structural body wherein the tape having a predetermined size along an outer peripheral shape is bonded on the end surface;

a moving type or tilt type mirror located in a position capable of reflecting a light reflected from the tape bonded to the end surface of the honeycomb structural body on the same axis as the laser oscillated from the laser oscillator and capable of being moved from the position on the same axis when the laser oscillates;

an image pick-up unit that picks up an image of the end surface of the honeycomb structural body reflected by the mirror, and

a processing position controller that positions the laser from the laser oscillator so as to cut the bonded tape into an intended shape based on the picked image,

wherein the tape bonder includes a winding element for winding a residual portion of the tape that is created after the tape is cut to leave the cut portion as a masking for non-plugging cells on the end surface of the honeycomb structure by the laser oscillator.

12. (New) A film bonding machine according to claim 1, further comprising a draw-out portion.

13. (New) A film bonding machine accroding to claim 1, further including a press unit.